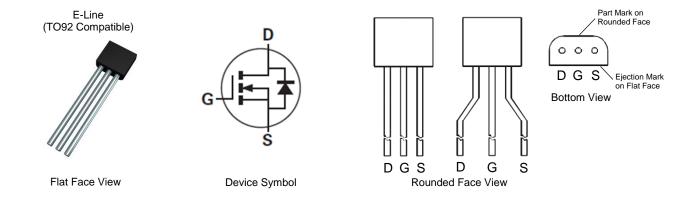


Features

- BV_{DSS} > 240V
- $R_{DS(ON)} \le 6\Omega @ V_{GS} = 2.5V$
- I_D = 260mA Maximum Continuous Drain Current
- Fast Switching Speed
- Low Threshold
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: E-Line (TO92 Compatible)
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Rating 94V-0
- Terminals: Finish Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208⁽³⁾
- Weight: 0.159 grams (Approximate)



Ordering Information (Note 4)

Part Number	Compliance	Package	Leads	Quantity
ZVN4424A	AEC-Q101	E-Line	Straight	4,000 Loose in a Box
ZVN4424ASTZ	AEC-Q101	E-Line	Joggled	2,000 Taped per Ammo Box

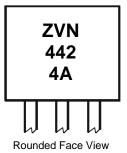
Notes: 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.

2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



ZVN 442 = Product Type Marking Code

4A



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Drain-Source Voltage	V _{DSS}	240	V
Gate-Source Voltage	V _{GSS}	±40	V
Continuous Drain Current	ID	260	mA
Pulsed Drain Current	I _{DM}	1.5	A

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Power Dissipation	(Note 5)	PD	750	mW
Thermal Resistance, Junction to Ambient	(Note 5)	R _{0JA}	167	°C/W
Thermal Resistance, Junction to Lead	(Note 6)	R _{θJL}	71	°C/W
Operating and Storage Temperature Range		T _J , T _{STG}	-55 to +150	°C

5. For a through-hole device mounted on the minimum recommended pad layout with 12mm lead length from the bottom of package to the single-sided Notes: FR-4 PCB; device is measured under still air conditions whilst operating in a steady-state.6. Thermal resistance from junction to solder-point at the seating plane (2.5mm from the bottom of package along the collector lead).

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	BV _{DSS}	240	_		V	$I_D = 1mA, V_{GS} = 0V$
Zero Gate Voltage Drain Current	I _{DSS}		_	10 100	μΑ	V _{DS} = 240V, V _{GS} = 0V V _{DS} = 190V, V _{GS} = 0V, T = +125°C
Gate-Source Leakage	Igss		_	100	nA	$V_{GS} = \pm 40V, V_{DS} = 0V$
ON CHARACTERISTICS						
Gate Threshold Voltage	V _{GS(TH)}	0.8	1.3	1.8	V	$I_D = 1mA, V_{DS} = V_{GS}$
Static Drain-Source On-Resistance (Note 7)	р	_	4	5.5	Ω	$V_{GS} = 10V, I_D = 500mA$
	R _{DS(ON)}		4.3	6		$V_{GS} = 2.5V, I_D = 500mA$
Forward Transconductance (Notes 7 & 9)	g fs	0.4	0.75	_	S	$V_{DS} = 10V, I_D = 0.5A$
DYNAMIC CHARACTERISTICS (Note 9)						
Input Capacitance	Ciss		110	200		$V_{DS} = 25V, V_{GS} = 0V$ f = 1.0MHz
Output Capacitance	Coss	_	15	25	pF	
Reverse Transfer Capacitance	C _{rss}	_	3.5	15		
Turn-On Delay Time (Note 8)	t _{D(ON)}	_	2.5	5		V _{DD} = 50V, V _{GEN} = 10V I _D = 0.25A
Turn-On Rise Time (Note 8)	t _R		5	8		
Turn-Off Delay Time (Note 8)	t _{D(OFF)}		40	60	ns	
Turn-Off Fall Time (Note 8)	t _F		16	25	1	

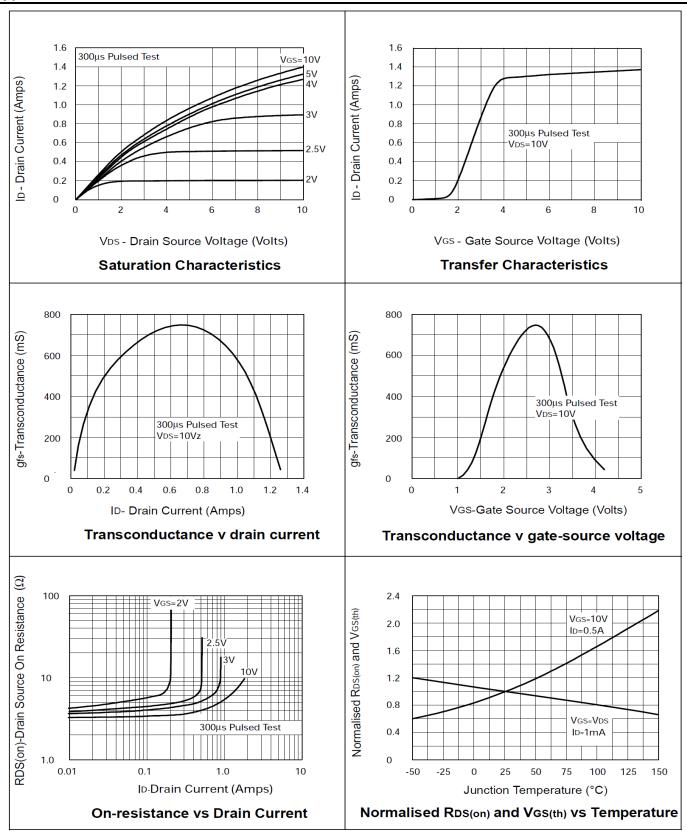
Notes: 7. Measured under pulsed conditions. Pulse width \leq 300µs. Duty cycle \leq 2%.

8. Switching characteristics are independent of operating junction temperature. Switching times are measured with 50Ω source impedance and <5ns rise time on a pulse generator.

9. For design aid only, not subject to production testing.

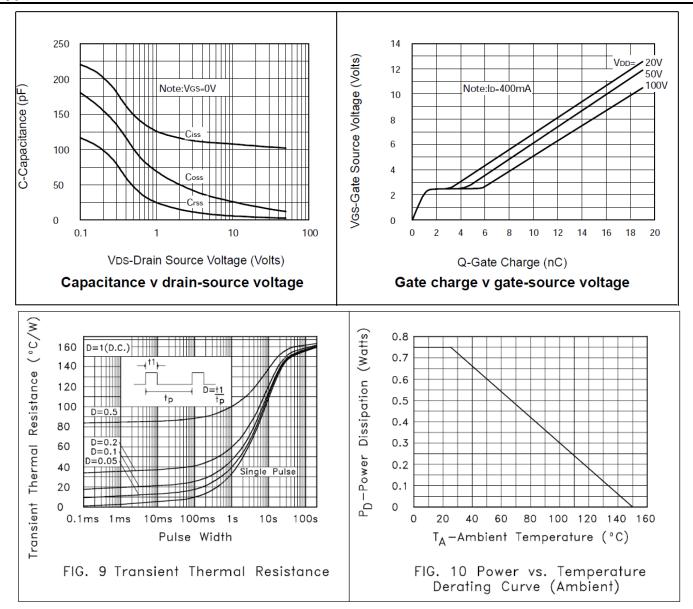


Typical Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)





Typical Electrical Characteristics (Cont.) (@T_A = +25°C, unless otherwise specified.)

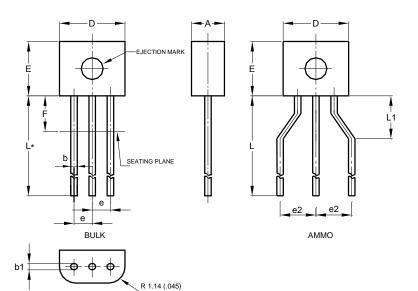




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

E-Line



E-Line					
Dim	Min	Max	Тур		
Α	2.16	2.41	-		
b	0.41	0.495	-		
b1	0.41	0.495	-		
D	4.37	4.77	-		
Е	3.61	4.01	-		
е	-	-	1.27		
e2	-	-	2.54		
F	_	2.50	_		
L	13.00	13.97	-		
L1	2.50	3.50	_		
All Dimensions in mm					



IMPORTANT NOTICE

DIODES INCORPORATED MAKES NO WARRANTY OF ANY KIND, EXPRESS OR IMPLIED, WITH REGARDS TO THIS DOCUMENT, INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION).

Diodes Incorporated and its subsidiaries reserve the right to make modifications, enhancements, improvements, corrections or other changes without further notice to this document and any product described herein. Diodes Incorporated does not assume any liability arising out of the application or use of this document or any product described herein; neither does Diodes Incorporated convey any license under its patent or trademark rights, nor the rights of others. Any Customer or user of this document or products described herein in such applications shall assume all risks of such use and will agree to hold Diodes Incorporated and all the companies whose products are represented on Diodes Incorporated website, harmless against all damages.

Diodes Incorporated does not warrant or accept any liability whatsoever in respect of any products purchased through unauthorized sales channel. Should Customers purchase or use Diodes Incorporated products for any unintended or unauthorized application, Customers shall indemnify and hold Diodes Incorporated and its representatives harmless against all claims, damages, expenses, and attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized application.

Products described herein may be covered by one or more United States, international or foreign patents pending. Product names and markings noted herein may also be covered by one or more United States, international or foreign trademarks.

This document is written in English but may be translated into multiple languages for reference. Only the English version of this document is the final and determinative format released by Diodes Incorporated.

LIFE SUPPORT

Diodes Incorporated products are specifically not authorized for use as critical components in life support devices or systems without the express written approval of the Chief Executive Officer of Diodes Incorporated. As used herein:

- A. Life support devices or systems are devices or systems which:
 - 1. are intended to implant into the body, or
 - 2. support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labeling can be reasonably expected to result in significant injury to the user.
- B. A critical component is any component in a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or to affect its safety or effectiveness.

Customers represent that they have all necessary expertise in the safety and regulatory ramifications of their life support devices or systems, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of Diodes Incorporated products in such safety-critical, life support devices or systems, notwithstanding any devices- or systems-related information or support that may be provided by Diodes Incorporated. Further, Customers must fully indemnify Diodes Incorporated and its representatives against any damages arising out of the use of Diodes Incorporated products in such safety-critical, life support devices or systems.

Copyright © 2016, Diodes Incorporated

www.diodes.com